



Product Change Notification

Change Notification #: 118946-00
Change Title: Intel® NUC Pro Assembly Element CMA1BB
Intel® NUC Pro Board Element CMB1BB,
PCN 118946-00, Product Design, Label,
Documentation
Firmware update and regulatory updates
Date of Publication: March 09, 2022

Key Characteristics of the Change:

Product Design, Label, Documentation

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	April 04, 2022
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Description of Change to the Customer:

1. The Embedded Controller Firmware for the products listed in the Products Affected / Intel Ordering Codes table below will be updated from version 2.17.0 to version 2.21.0.
2. Add UKCA logo on the rating label.
3. Add UKCA sticker to the board.
4. Update Regulatory Flyer to -003 for UKCA.

Change from old part	Change to new part
 Intel® NUC Pro Board Element Intel® NUC Pro 電腦元件主板 Intel® NUC Pro 电脑元件主板 INTEL CORPORATION 2200 Mission College Blvd., Santa Clara, CA 95054 USA Product code: 型號/型号/Regulatory Model: CM1BB 製造日期/制造日期/ Date of Manufacture: 中國製造/中国制造/Made In China CAN ICES-3(B)/NMB-3(B) FC CE 10 D33025 R-R-CPU-CM1BB RoHS	 Intel® NUC Pro Board Element Intel® NUC Pro 電腦元件主板 Intel® NUC Pro 电脑元件主板 INTEL CORPORATION Product code: 型號/型号/Regulatory Model: CM1BB 製造日期/制造日期/ Date of Manufacture: 中國製造/中国制造/Made In China CAN ICES-3(B)/NMB-3(B) FC CE 10 R33025 R-R-CPU-CM1BB RoHS UK CA
	

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new Embedded Controller Firmware to ensure a smooth transition. This change has been thoroughly evaluated to ensure that there are no known quality or reliability implications to our customers.

The change to the label does not affect the functionality of the product. Customer should be aware of these changes and take any actions so as to not impact their receiving and integration of product with the new label,

Milestone dates are estimates and subject to change based on business and operational conditions.

Customer can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
Intel® NUC Pro Board Element CMB1BB, 5 pack	BKCMB1BB	999M8T		K60964-204		K60964-205
Intel® NUC Pro Assembly Element CMA1BB, 5 pack	BKCMA1BB	999M9F	K73388-204	K60964-204	K73388-205	K60964-205

PCN Revision History:

Date of Revision:

March 09, 2022

Revision Number:

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Reason:

Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

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Japan Email: jccb.ijkk@intel.com

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